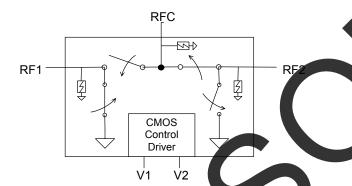


Product Description

The PE4283 RF Switch is designed to cover a broad range of applications from DC through 4000 MHz. This reflective switch integrates on-board CMOS control logic with a low voltage CMOS-compatible control interface, and can be controlled using either single-pin or complementary control inputs. The PE4283 operates using a +3 volt power supply.

The PE4283 SPDT High Power RF Switch is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Diagram



Product Specification

PE4283

SPDT High Power UltraCMOS™ DC – 4.0 GHz RF Switch

Features

- Single-pin or complementary CMOS logic control inputs
- 1.5 kV ESD tolerance
- Low insertion loss: 0.65 dB at 1000 MHz, 0.70 dB at 2500 MHz
- RFC-RF1/RF2 isolation of 33.5 dB at 1000 MHz, 21.5 dB at 2500 MHz
- RF1-RF2 isolation of 37.5 dB at 1000 MHz, 22 dB at 2500 MHz
- Typical input 1 dB compression point of +32 dBm
- Ultra-small SC 70 package

Figure 2. Package Type SC-70

6-lead SC-70



Table 1. Electrical Specifications @ +25 °C, $V_{DD} = 3$ V ($\Sigma = Z_L = 50 \Omega$)

Parameter	Conditions	Min	Typical	Max	Units
Operation Frequency ¹	DC -4000	DC		4000	MHz
Insertion Loss	1000 MHz 2500 MHz		0.65 0.70	0.75 0.80	dB dB
Isolation: RFC - RF1/RF2	1000 MHz 2500 MHz	31.5 19.5	33.5 21.5		dB dB
Isolation: RF1 - RF2	1000 MHz 2500 MHz	35.5 20	37.5 22		dB dB
Return Loss	1000 MH2 2:00 MH2		19 16		dB dB
'ON' Switching Time	50% CTRL to 0.1 dB of final value, 1 GHz		0.725	1.5	μs
'OFF' Switching Time	50% CTRL to 25 dB isolation, 1 GHz		0.625	1.3	μs
Input 1 dB Compression	1000 MHz	30	+32		dBm
Input IP3	1000 MHz, 20 dBm input power		+53		dBm

Note: 1. Device linearity will begin to degrade below 10 MHz.



Figure 3. Pin Configuration (Top View)

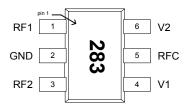


Table 2. Pin Descriptions

Pin No.	Pin Description	
1	RF1	RF Port1 ²
2	GND	Ground connection. Traces should be physically short and connected to ground plane for best performance.
3	RF2	RF Port2 ²
4	V1	Switch control input, CMOS logic level.
5	RFC	RF Common ²
6	V2	This pin supports two interface options: Single-pin control mode. A nominal 3-volt supply connection is required. Complementary-pin control mode. complementary CMOS control to V1 is supplied to this pin.

Note: 2. All RF pins must be DC blocked with an external series capacitor or held at 0 VDC.

Table 3. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Мах	Units
V_{DD}	Power supply voltage	-0.3	4.0	^
Vı	Voltage on any DC input	-0.3	V _{DD} + 0.3	V
T _{ST}	Storage temperature range	-65	150	ů
T _{OP}	Operating temperature range	-40	85	Ç
P _{IN}	Input power (50Ω)		+34	dBm
V _{ESD}	ESD Voltage (HBM), ML_STD 883 Method 3015.7)		1500	V
	ESD Voltage (MM, JEDEC, JESD22-X114-B)	X	100	V

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Table 4. Operating Ranges

Parameter	Min	Тур	Max	Units
V _{DD} Power Supply Voltage	2.0	3.0	3.3	٧
I _{DD} Power Supply Current (V1 = 3V, V2 = 3V)		8	50	μA
Control Voltage High	0.7x V _{DD}			V
Control Voltage Low			0.3x V _{DD}	V

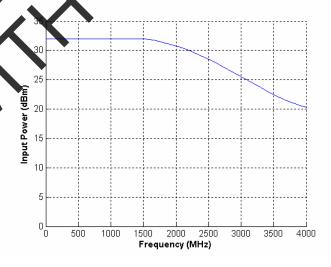
Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Electrostatic Discharge (ESD) Presautions

When handling this UltraCMOS W device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 3.

Figure 4. Maximum Operating Input Power³



Note: 3. Operating within DC limits (Table 4).



Table 5. Single-pin Control Logic Truth Table

Control Voltages	Signal Path		
Pin 6 $(V2) = V_{DD}$ Pin 4 $(V1) = High$	RFC to RF1		
Pin 6 (V2) = V _{DD} Pin 4 (V1) = Low	RFC to RF2		

Table 6. Complementary-pin Control Logic **Truth Table**

Control Voltages	Signal Path		
Pin 6 (V2) = Low Pin 4 (V1) = High	RFC to RF1		
Pin 6 (V2) = High Pin 4 (V1) = Low	RFC to RF2		

Control Logic Input

The PE4283 is a versatile RF CMOS switch that supports two operating control modes; single-pin control mode and complementary-pin control mode.

Single-pin control mode enables the switch to operate with a single control pin (pin 4) supporting a +3-volt CMOS logic input, and requires a dedicated +3-volt power supply connection (pin 6). This mode of operation reduces the number of control lines required and simplifies the switch control interface typically derived from a CMOS μProcesson I/O port.

Complementary-pin control mode all switch to operate using complement pins VI and V2 (pin s 4 & 6). tr driven by +3-volt CMOS logic d r a suitable µProcessor / port. This tage mode within the operate in positive contr E4283



Evaluation Kit

The SPDT switch EK Board was designed to ease customer evaluation of Peregrine's PE4283. The RF common (RFC) port is connected through a 50 Ω transmission line via the top SMA connector, J1. RF1 and RF2 are connected through 50 Ω transmission lines via SMA connectors J2 and J3, respectively. A through 50 Ω transmission is available via SMA connectors J4 and J5. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a two metal layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.0476", trace gaps of 0.030", dielectric thickness of 0.028", metal thickness of 0.0021" and ε_r of 4.4.

J6 and J7 provide a means for controlling DC and digital inputs to the device. J6-1 is connected to the device V2 input. J7-1 is connected to the device V1 input. Series resistors (R1 and R2) are provided to reduce the package resonance between RF and DC lines.

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Figure 5. Evaluation Board Layouts

Peregrine Specification 101/0162

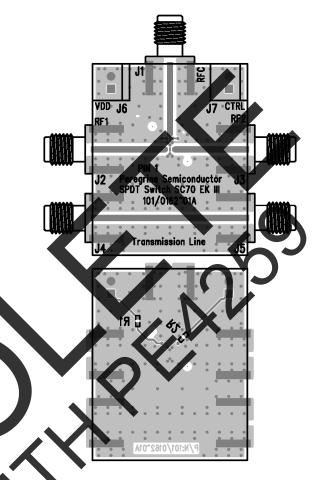


Figure 6. Evaluation Board Schematic

Palegrine Specification 102/0322



Figure 7. Insertion Loss @ 25 °C

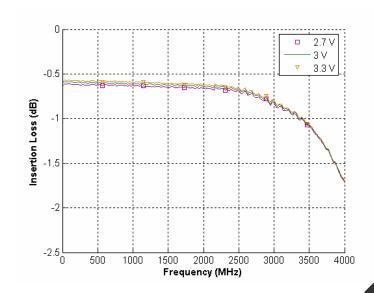


Figure 8. Insertion Loss @ 3 V

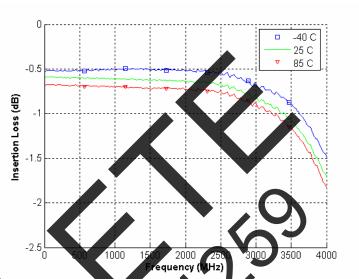


Figure 9. Isolation: RF1-RF2 @ 25 °C

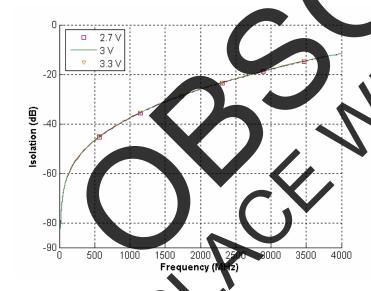


Figure 10. ation: RF1-RF2 @ 3 V

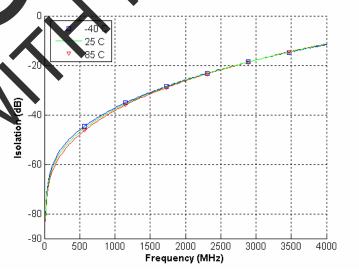




Figure 11. Isolation: RFC-RF1/RF2 @ 25 °C

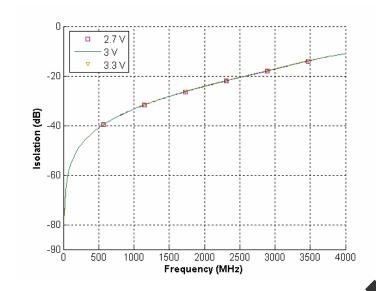


Figure 12. Isolation: RFC-RF1/RF2 @ 3 V

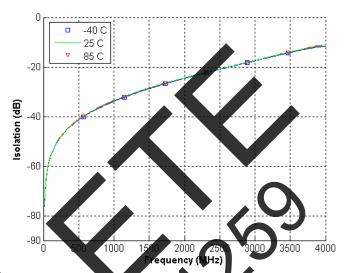
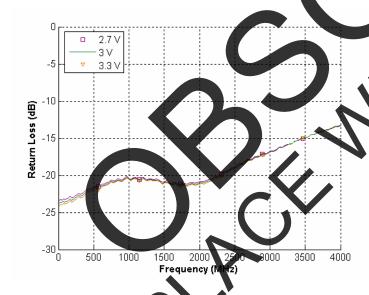


Figure 13. Return Loss: RF1-RF2 @ 25 °



igure 14. efurn Loss: RF1-RF2 @ 3 V

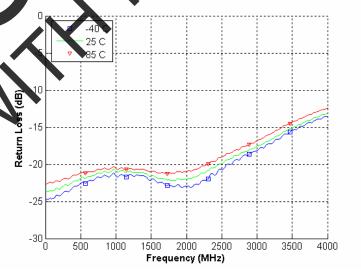




Figure 15. Return Loss: RFC-RF1 @ 25 °C

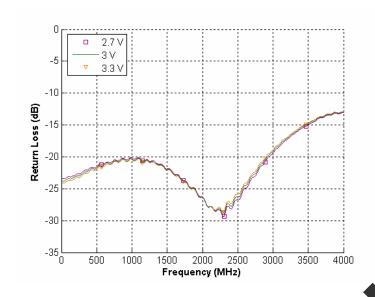


Figure 16. Return Loss RFC-RF1 @ 3 V

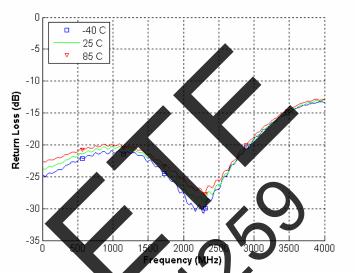


Figure 17. Return Loss: RFC-RF2 @ 25

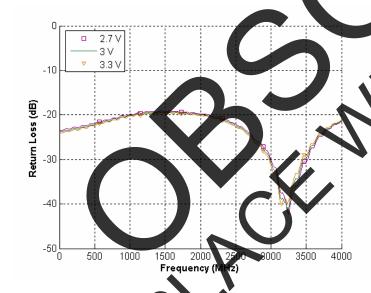


Figure 18. furn Loss: RFC-RF2 @ 3 V

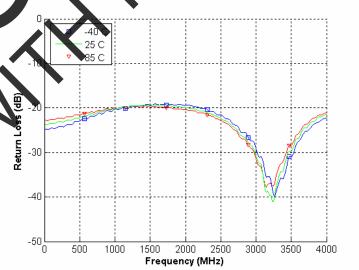


Figure 19. Input 1 dB Compression and IIP3

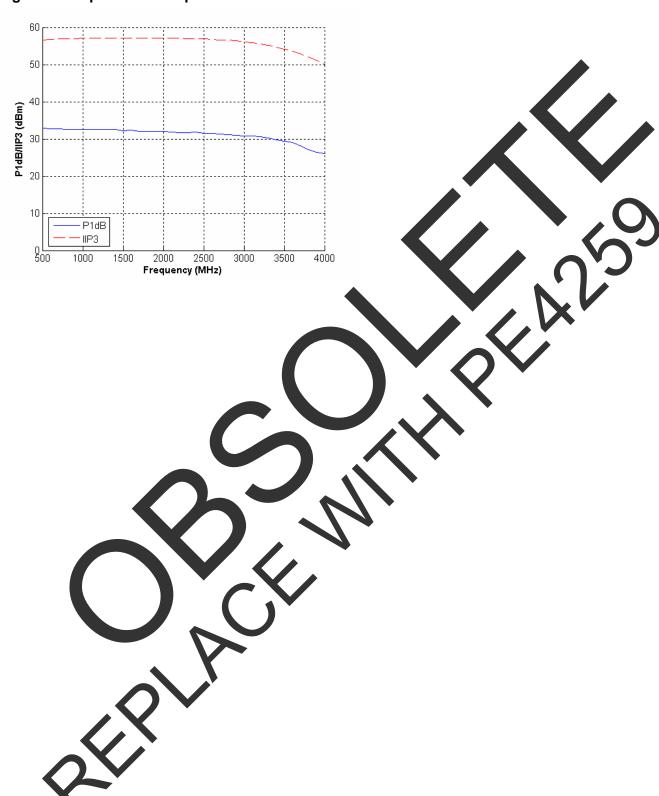




Figure 20. Package Drawing

6-lead SC-70

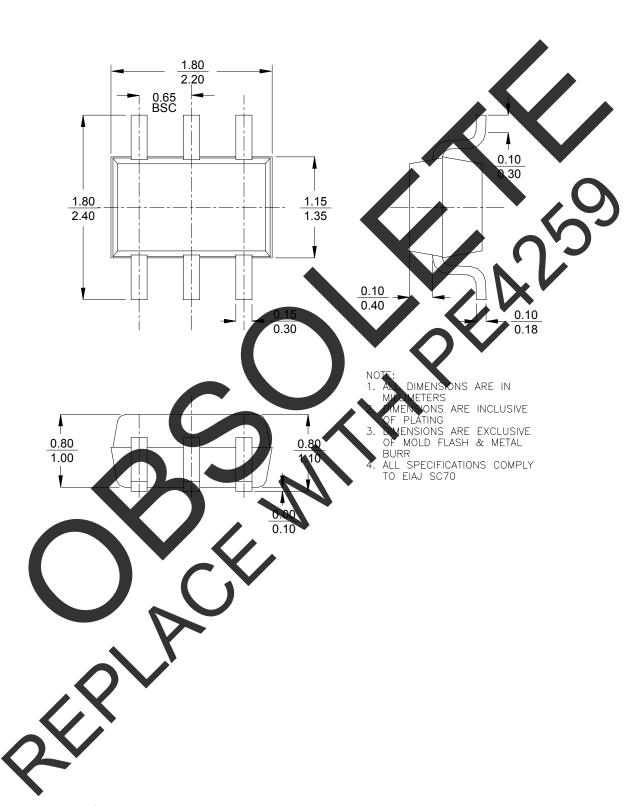
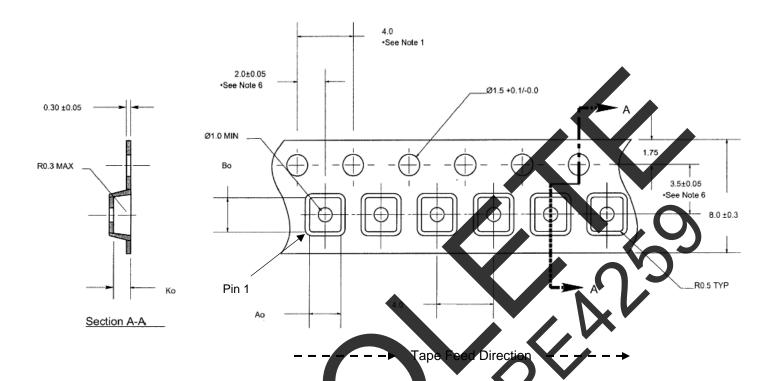




Figure 21. Tape and Reel Specifications



Notes:

- 1. 10 sprocket hole pitch cumulative toler
- 2. Camber not to exceed 1mm in 100m
- 3. Material: Black Conductive Advantek
- 4. Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
- 5. Ko measured from a plan e on the the pocket to the top surfa
- 6. Pocket position relative to : cket hole true position of

Table 7. Ordering Information

	Order Code	Part Marking	-	Description	Package	Shipping Method
	4283-00	PE4283-EK		PE4283-06SC70-EK	Evaluation Kit	1 / Box
	4283-51	283		PE4283G-06SC70-7680A	Green 6-lead SC-70	7680 units / Canister
	4283-52	283		PE4283G-06SC70-3000C	Green 6-lead SC-70	3000 units / T&R



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Tel: 5211 502-521

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